

T-31-15

## SILICON PLANAR EPITAXIAL TRANSISTOR

P-N-P transistor in a microminiature plastic envelope, intended for applications in thick and thin-film circuits such as self-oscillating mixer in u.h.f. tuners in conjunction with bipolar transistors or with MOS fets.

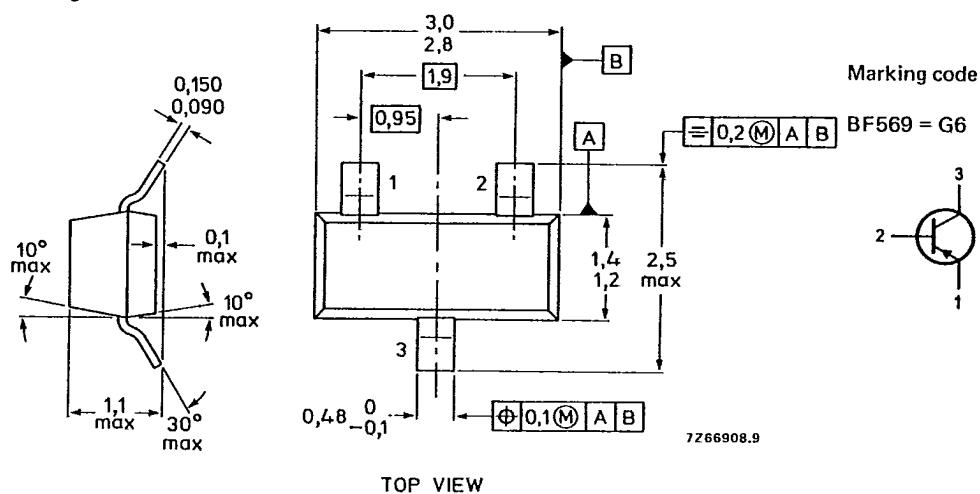
## QUICK REFERENCE DATA

Collector-base voltage (open emitter)	$-V_{CBO}$	max.	40 V
Collector-emitter voltage (open base)	$-V_{CEO}$	max.	35 V
Collector current (d.c.)	$-I_C$	max.	30 mA
Total power dissipation up to $T_{amb} = 60^\circ\text{C}$	$P_{tot}$	max.	200 mW
Junction temperature	$T_j$	max.	150 $^\circ\text{C}$
Transition frequency at $f = 100 \text{ MHz}$ $I_E = 3 \text{ mA}; -V_{CB} = 10 \text{ V}$	$f_T$	typ.	900 MHz

## MECHANICAL DATA

Fig. 1 SOT-23

Dimensions in mm



TOP VIEW

See also *Soldering recommendations*.

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**RATINGS**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-base voltage (open emitter)	-V <sub>CBO</sub>	max.	40 V
Collector-emitter voltage (open base)	-V <sub>CEO</sub>	max.	35 V
Emitter-base voltage (open collector)	-V <sub>EBO</sub>	max.	3 V
Collector current (d.c.)	-I <sub>C</sub>	max.	30 mA
Total power dissipation up to T <sub>amb</sub> = 60 °C**	P <sub>tot</sub>	max.	200 mW
Storage temperature	T <sub>stg</sub>		-65 to + 150 °C
Junction temperature	T <sub>j</sub>	max.	150 °C

**THERMAL CHARACTERISTICS\***

$$T_j = P \times (R_{th\ j-t} + R_{th\ t-s} + R_{th\ s-a}) + T_{amb}$$

**Thermal resistance**

From junction to tab	R <sub>th\ j-t</sub>	=	60 K/W
From tab to soldering points	R <sub>th\ t-s</sub>	=	280 K/W
From soldering points to ambient**	R <sub>th\ s-a</sub>	=	90 K/W

**CHARACTERISTICS**T<sub>j</sub> = 25 °C unless otherwise specified.**Collector cut-off current**I<sub>E</sub> = 0; -V<sub>CB</sub> = 20 V-I<sub>CBO</sub> < 100 nA**D.C. current gain**I<sub>E</sub> = 3 mA; -V<sub>CB</sub> = 10 Vh<sub>FE</sub> > typ. 25  
typ. 50**Transition frequency at f = 100 MHz**I<sub>E</sub> = 3 mA; -V<sub>CB</sub> = 10 Vf<sub>T</sub> typ. 900 MHz**Feedback capacitance at f = 1 MHz**I<sub>E</sub> = 1 mA; -V<sub>CB</sub> = 10 VC<sub>re</sub> typ. 0,33 pF**Noise figure at f = 800 MHz**I<sub>E</sub> = 3 mA; -V<sub>CB</sub> = 10 V; R<sub>S</sub> = 60 Ω; R<sub>L</sub> = 500 Ω

F typ. 4,5 dB

**Power gain at f = 800 MHz**I<sub>E</sub> = 3 mA; -V<sub>CB</sub> = 10 V; R<sub>S</sub> = 60 Ω; R<sub>L</sub> = 500 ΩG<sub>pb</sub> typ. 14,5 dB\* See *Thermal characteristics*.

\*\* Mounted on a ceramic substrate of 8 mm x 10 mm x 0,7 mm.

Silicon planar epitaxial transistor

BF569

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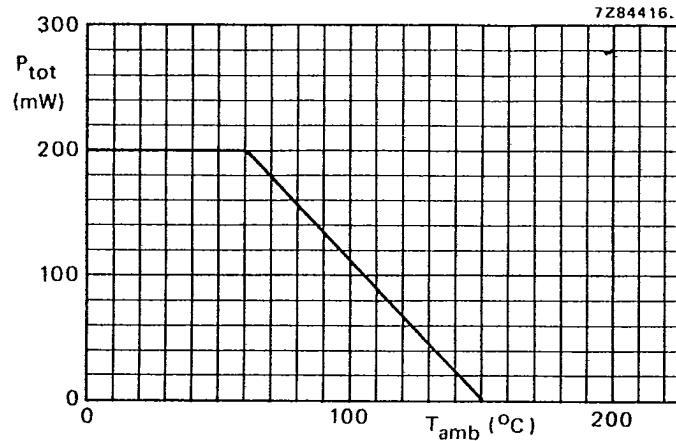


Fig. 2 Power derating curve.